



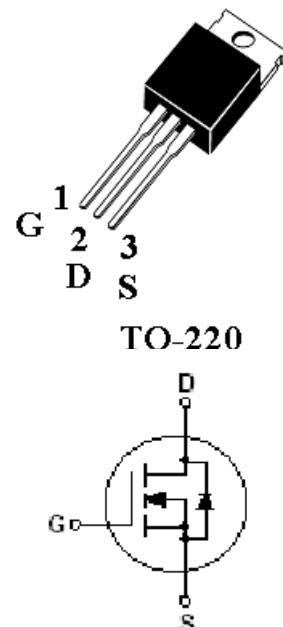
50A 60V N Channel Mosfet

APPLICATIONS

Low Voltage high-Speed Switching.

ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ\text{C}$)

T_{stg}	Storage Temperature	-55~175 °C
T_j	Operating Junction Temperature	150°C
P_D	Allowable Power Dissipation ($T_c=25^\circ\text{C}$)	130W
V_{DSS}	Drain-Source Voltage	60V
V_{GSS}	Gate-Source Voltage	$\pm 20\text{V}$
I_D	Drain Current ($T_c=25^\circ\text{C}$)	50A



ELECTRICAL CHARACTERISTICS ($T_a=25^\circ\text{C}$)

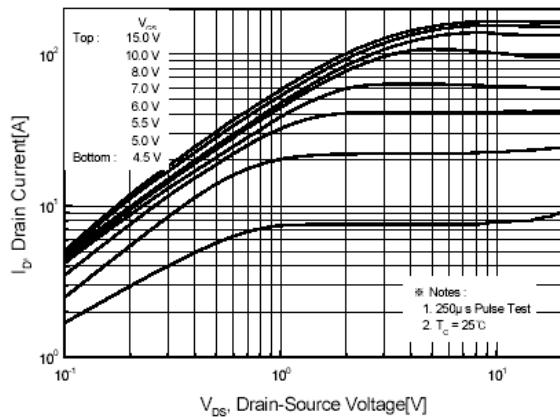
Symbol	Characteristics	Min	Typ	Max	Unit	Test Conditions
BV_{DSS}	Drain-Source Breakdown Voltage	60			V	$I_D=250\text{ }\mu\text{A}, V_{GS}=0\text{V}$
I_{DSS}	Zero Gate Voltage Drain Current			1	μA	$V_{DS}=60\text{V}, V_{GS}=0$
I_{GSS}	Gate -Source Leakage Current			± 100	nA	$V_{GS}=\pm 20\text{V}, V_{DS}=0\text{V}$
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS}=V_{GS}, I_D=250\text{ }\mu\text{A}$
$R_{DS(on)}$	Static Drain-Source On-Resistance		0. 018	0. 023	Ω	$V_{GS}=10\text{V}, I_D=25\text{A}$
C_{iss}	Input Capacitance	880	1140		pF	$V_{DS}=25\text{V}, V_{GS}=0, f=1\text{MHz}$
C_{oss}	Output Capacitance	430	560		pF	
C_{rss}	Reverse Transfer Capacitance	110	140		pF	
$t_{d(on)}$	Turn - On Delay Time	60	130		nS	$V_{DD}=30\text{V}, I_D=25\text{A}$ $R_G=50\text{ }\Omega^*$
tr	Rise Time	185	380		nS	
$t_{d(off)}$	Turn - Off Delay Time	75	160		nS	
t_f	Fall Time	60	130		nS	
Q_g	Total Gate Charge		39	45	nC	$V_{DS}=48\text{V}$ $V_{GS}=10\text{V}$ $I_D=50\text{A}^*$
Q_{gs}	Gate-Source Charge		9.5		nC	
Q_{gd}	Gate-Drain Charge		13		nC	
I_s	Continuous Source Current			50	A	
V_{SD}	Diode Forward Voltage			1. 5	V	$I_s=50\text{A}, V_{GS}=0$
$R_{th(j-c)}$	Thermal Resistance, Junction-to-Case			1. 15	$^\circ\text{C/W}$	

*Pulse Test: Pulse Width $\leqslant 300\text{ }\mu\text{s}$, Duty Cycle $\leqslant 2\%$



50A 60V N Channel Mosfet

Fig 1. On-State Characteristics



**Fig 3. On Resistance Variation vs.
Drain Current and Gate Voltage**

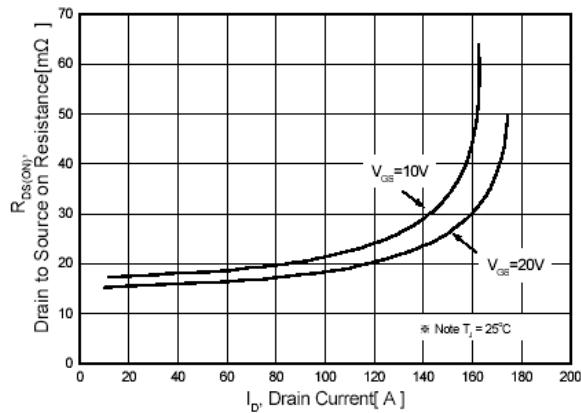


Fig 5. Capacitance Characteristics

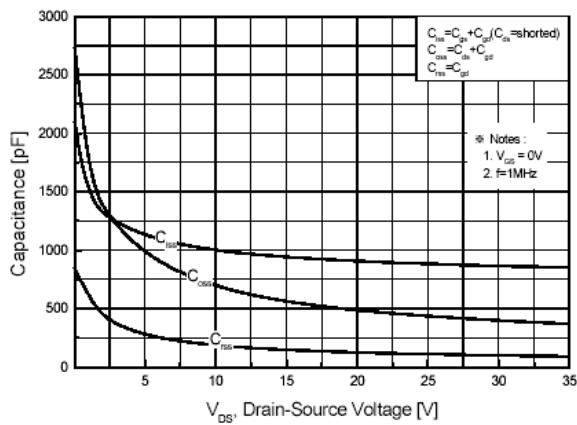
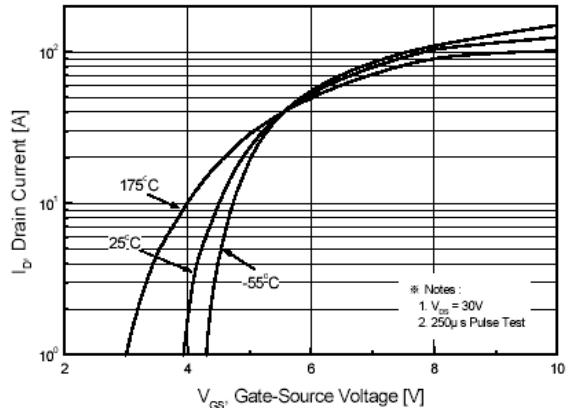


Fig 2. Transfer Characteristics



**Fig 4. On State Current vs.
Allowable Case Temperature**

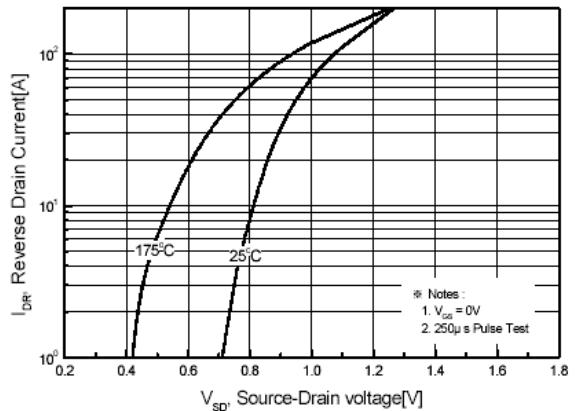
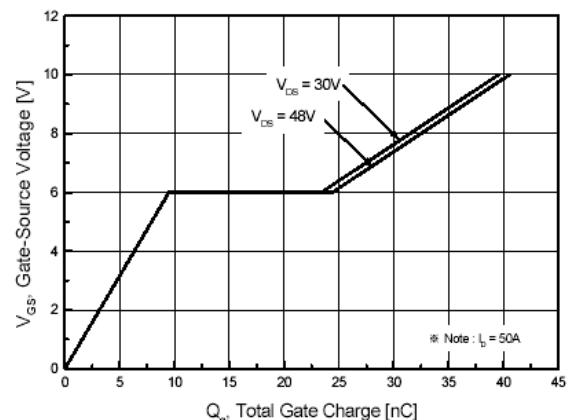


Fig 6. Gate Charge Characteristics





50A 60V N Channel Mosfet

Fig 7. Breakdown Voltage Variation vs. Junction Temperature

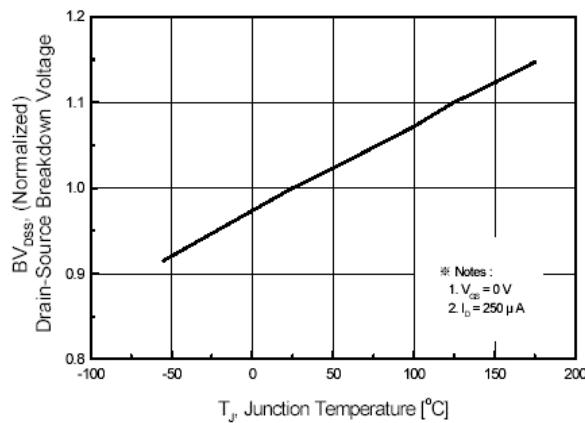


Fig 8. On-Resistance Variation vs. Junction Temperature

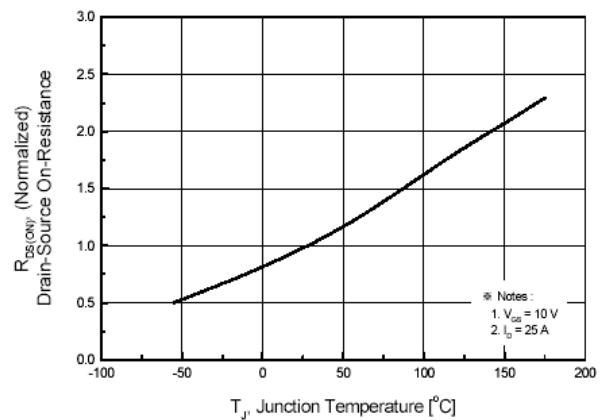


Fig 9. Maximum Safe Operating Area

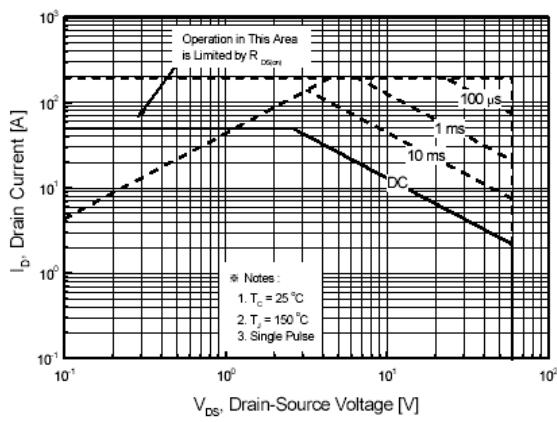


Fig 10. Maximum Drain Current vs. Case Temperature

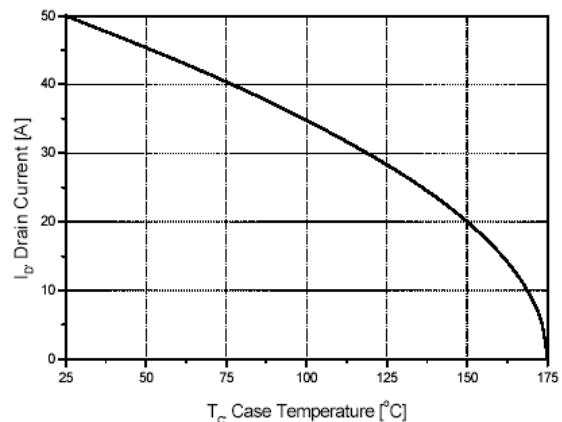
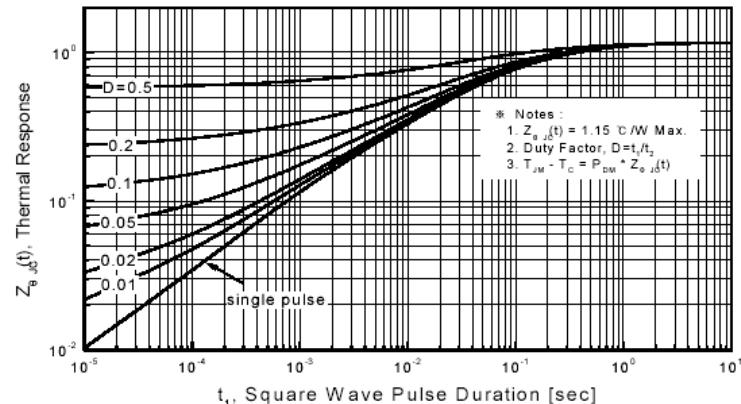


Fig 11. Transient Thermal Response Curve





50A 60V N Channel Mosfet

Fig. 12. Gate Charge Test Circuit & Waveforms

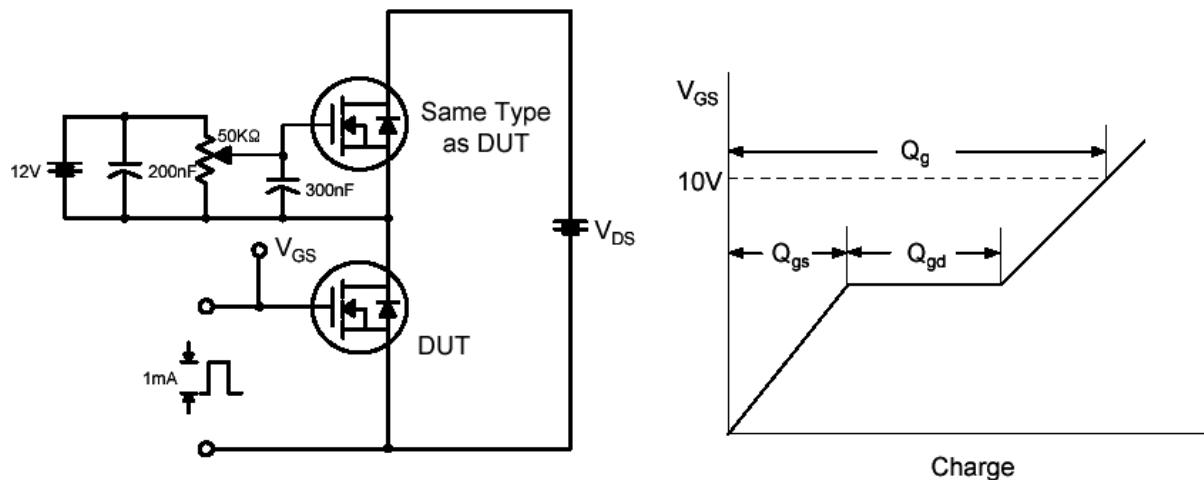


Fig 13. Switching Time Test Circuit & Waveforms

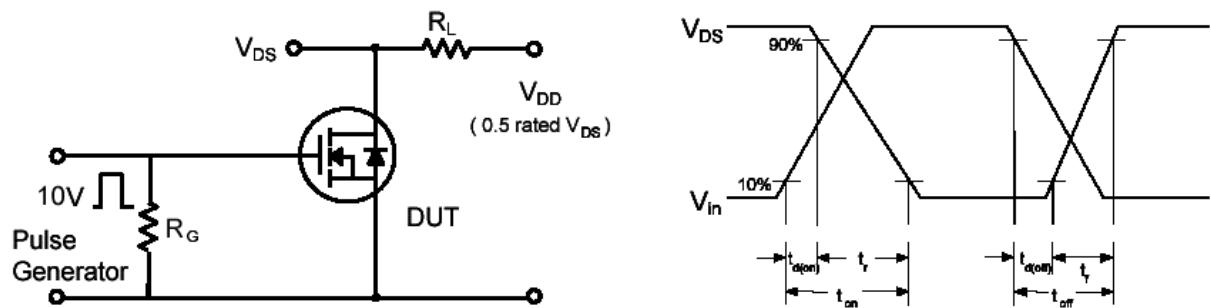
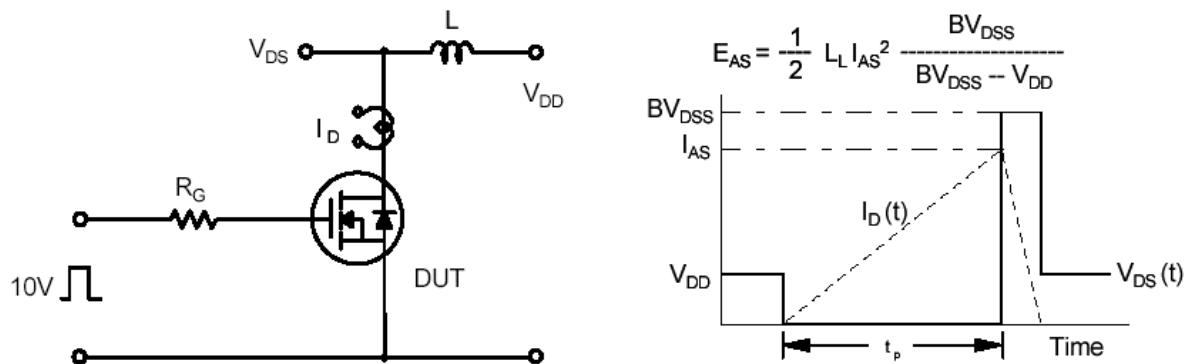


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms





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